



IN THE UNITED STATES PATENTS AND TRADEMARK OFFICE

K-1948

Applicant : Ryoh Itoh
Title : METHOD FOR PARTIALLY PLATING ON A BASE
Serial No. : 09/735,931
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Examiner : Brian K. Talbot

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Hon. Director of Patents and Trademarks
Washington. D. C. 20231

February 13, 2003

AMENDMENT

Sir:

In response to the Office Action of November 4, 2002, please amend the application, as follows:

IN THE SPECIFICATION

Delete page 4, lines 3-30, and add, as follows:

In the cases of the methods [3] and [4], the catalyst applying process (3) and the coated material removing process (4) may be conducted at the same time. Further, the catalyst applying process (3) may be followed by a preliminary plating process.

On the other hand, in the case of the method [5], an additional plating process may be conducted after the coated material removing process (5).

BRIEF DESCRIPTION OF THE DRAWINGS

Figs. 1(A) and 1(B) show a base according to an example of the present invention, wherein Fig. 1(A) and 1(B) are a perspective view and a partially cutaway view thereof, respectively.